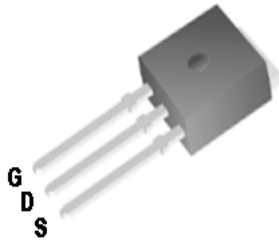


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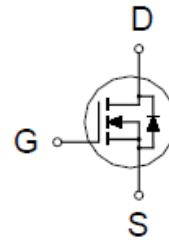
N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
60V	10m Ω @ $V_{GS} = 10V$	66A



TO-251



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current ²	$T_C = 25\text{ }^\circ\text{C}$	I_D	66	A
	$T_C = 100\text{ }^\circ\text{C}$		42	
Pulsed Drain Current ¹		I_{DM}	150	
Avalanche Current		I_{AS}	38.5	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	74	mJ
Power Dissipation	$T_C = 25\text{ }^\circ\text{C}$	P_D	96	W
	$T_C = 100\text{ }^\circ\text{C}$		38	
Junction & Storage Temperature Range		T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		1.3	$^\circ\text{C} / \text{W}$
Junction-to-Ambient	$R_{\theta JA}$		62.5	

¹Pulse width limited by maximum junction temperature.

²Package limitation current is 30A.

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS		
			MIN	TYP	MAX			
STATIC								
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	60			V		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.3	1.8	2.3	V		
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V			±100	nA		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 80V, V _{GS} = 0V			1	μA		
		V _{DS} = 40V, V _{GS} = 0V, T _J = 125 °C			10			
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 4.5V, I _D = 20A		8.1	13	mΩ		
		V _{GS} = 10V, I _D = 20A		6.8	10			
Forward Transconductance ¹	g _{fs}	V _{DS} = 10V, I _D = 20A		60		S		
DYNAMIC								
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz		1920		pF		
Output Capacitance	C _{oss}			215				
Reverse Transfer Capacitance	C _{rss}			140				
Gate Resistance	R _g	V _{GS} = 0V, V _{DS} = 0V, f = 1MHz		0.7		Ω		
Total Gate Charge ²	Q _{g(VGS=10V)}	V _{DS} = 30V, I _D = 20A		42		nC		
	Q _{g(VGS=4.5V)}			23				
Gate-Source Charge ²	Q _{gs}			6				
Gate-Drain Charge ²	Q _{gd}			12				
Turn-On Delay Time ²	t _{d(on)}		V _{DS} = 30V, I _D ≅ 20A, V _{GS} = 10V, R _{GEN} = 6Ω		29			nS
Rise Time ²	t _r				31			
Turn-Off Delay Time ²	t _{d(off)}			51				
Fall Time ²	t _f			31				
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)								
Continuous Current ³	I _S				66	A		
Forward Voltage ¹	V _{SD}	I _F = 20A, V _{GS} = 0V			1.3	V		
Diode Reverse Recovery Time	t _{rr}	I _F = 20A, dI/dt = 100A / μS		26		nS		
Diode Reverse Recovery Charge	Q _{rr}			19		nC		

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

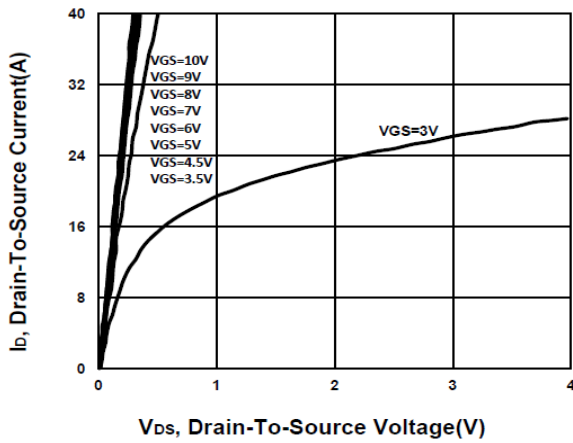
²Independent of operating temperature.

³Package limitation current is 30A.

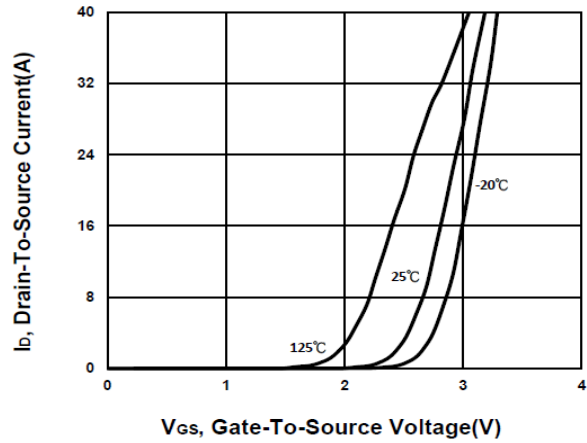
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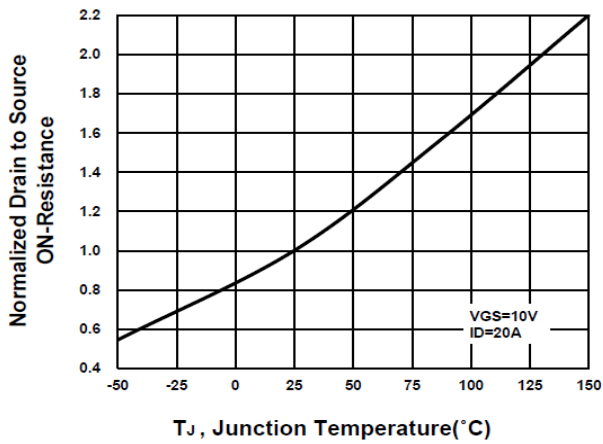
Output Characteristics



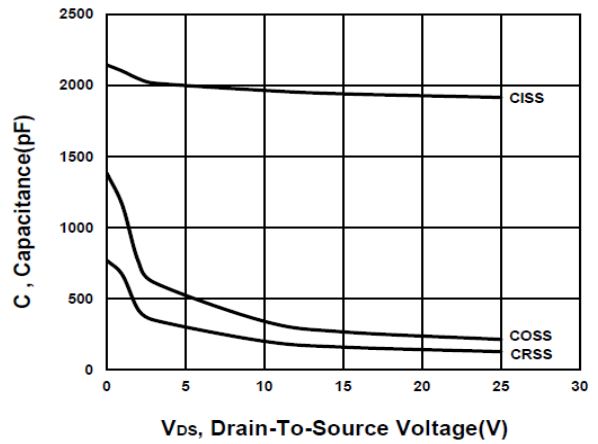
Transfer Characteristics



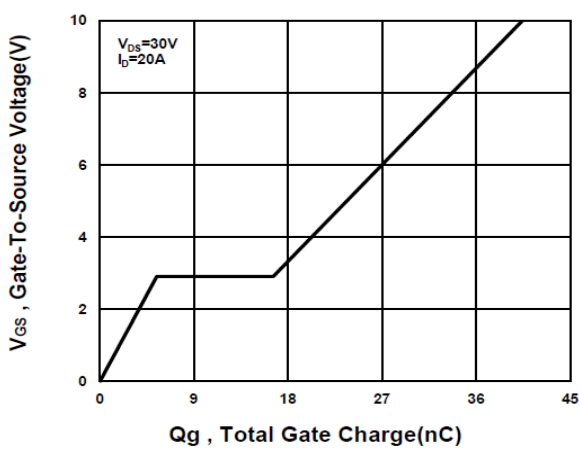
On-Resistance VS Temperature



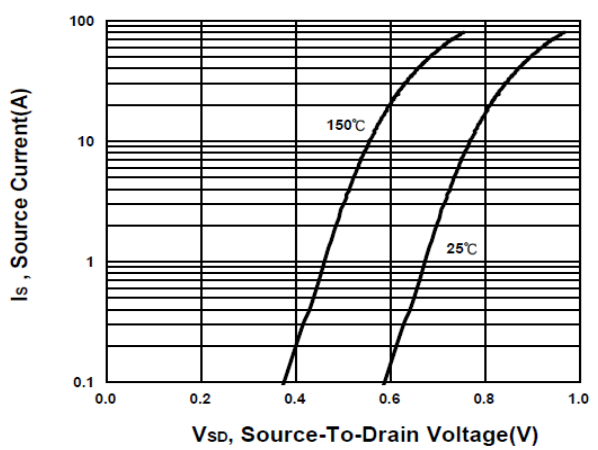
Capacitance Characteristic



Gate charge Characteristics



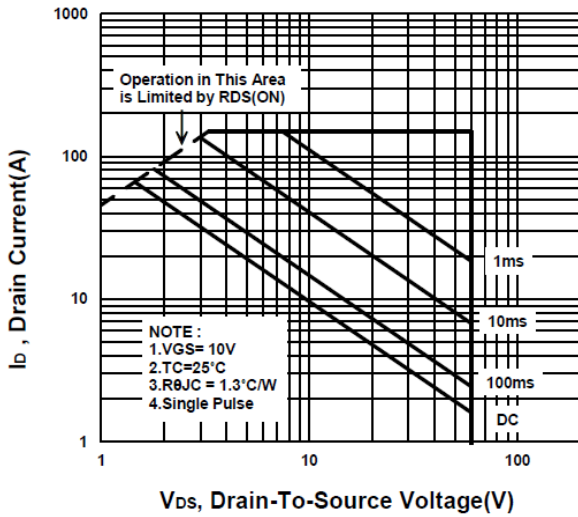
Source-Drain Diode Forward Voltage



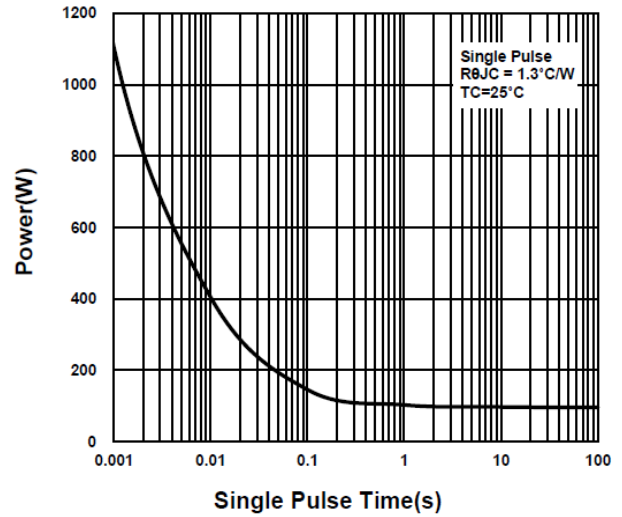
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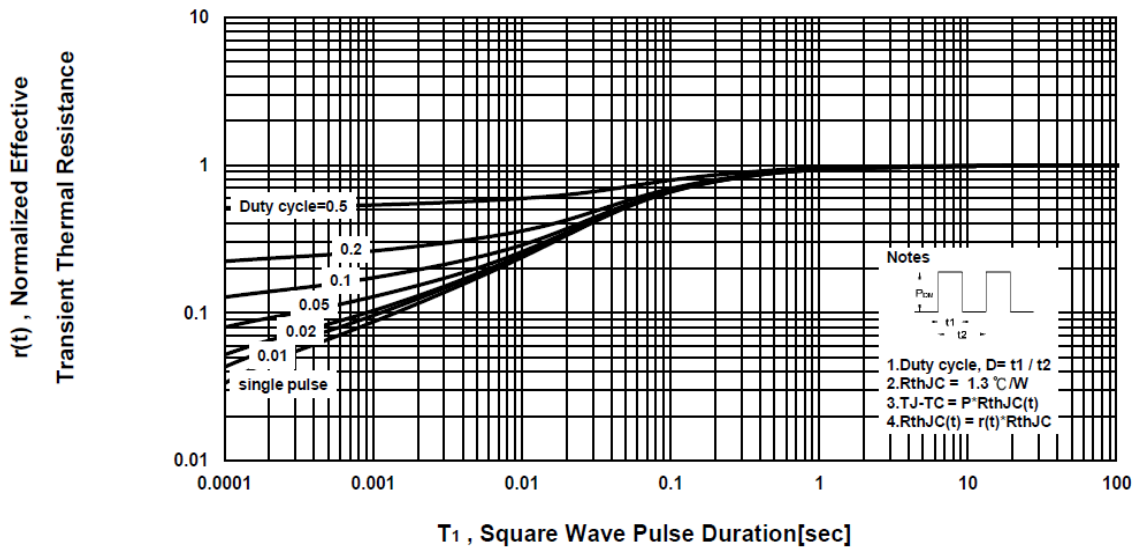
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



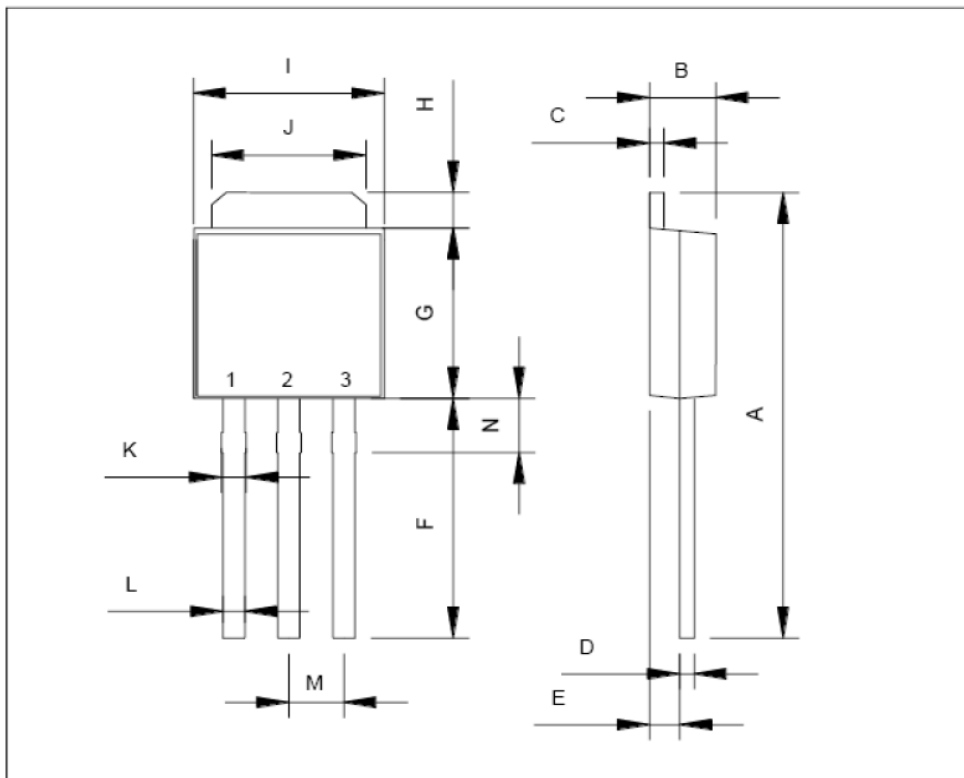
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Package Dimension

TO-251 MECHANICAL DATA

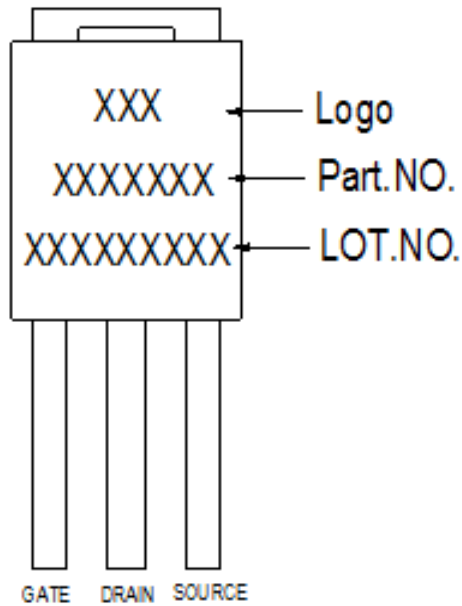
Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	14	15	17.14	H	0.89		1.7
B	2.1	2.3	2.5	I	6.3		6.8
C	0.4	0.5	0.6	J	4.8		5.5
D	0.35	0.5	0.65	K	0.5	0.84	1.14
E	0.9	1.1	1.5	L	0.4	0.76	0.912
F	7		9.65	M		2.3	
G	5.3		6.22	N	1.4	2.16	2.23



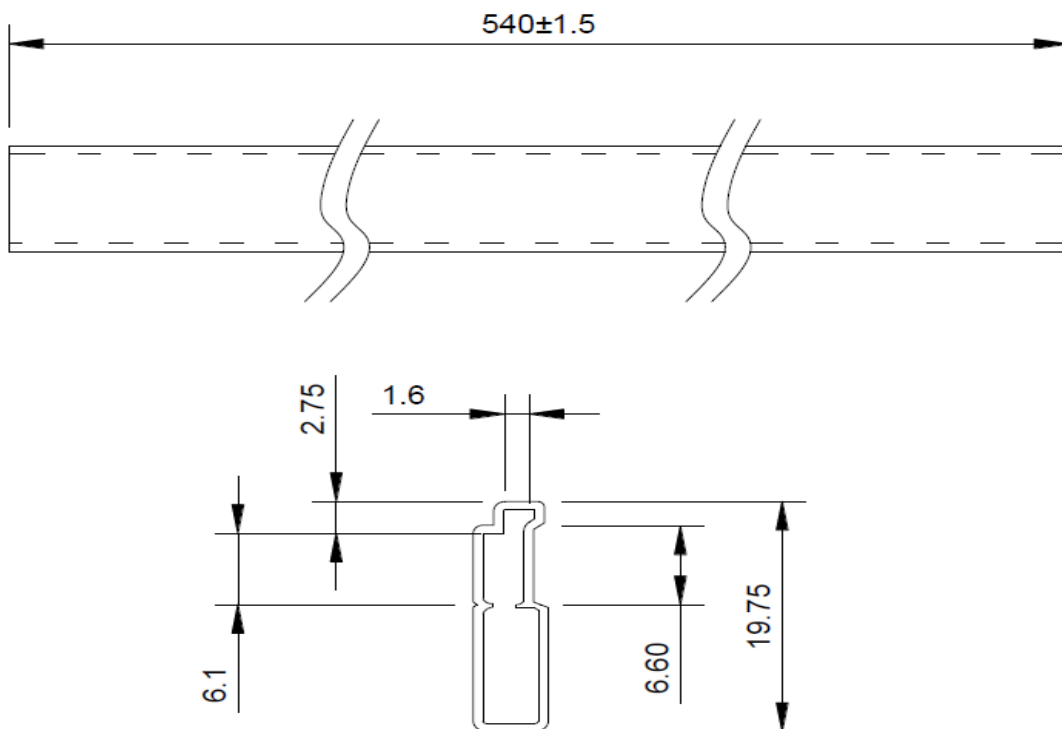
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A. Marking Information



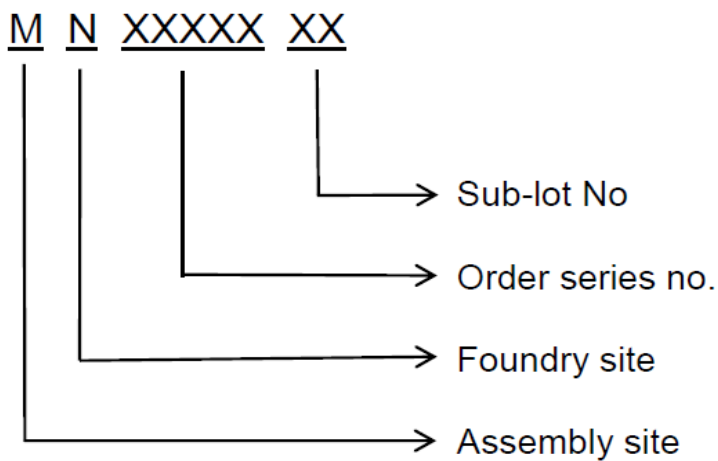
B. Tape & Reel Information: 75pcs/Tube



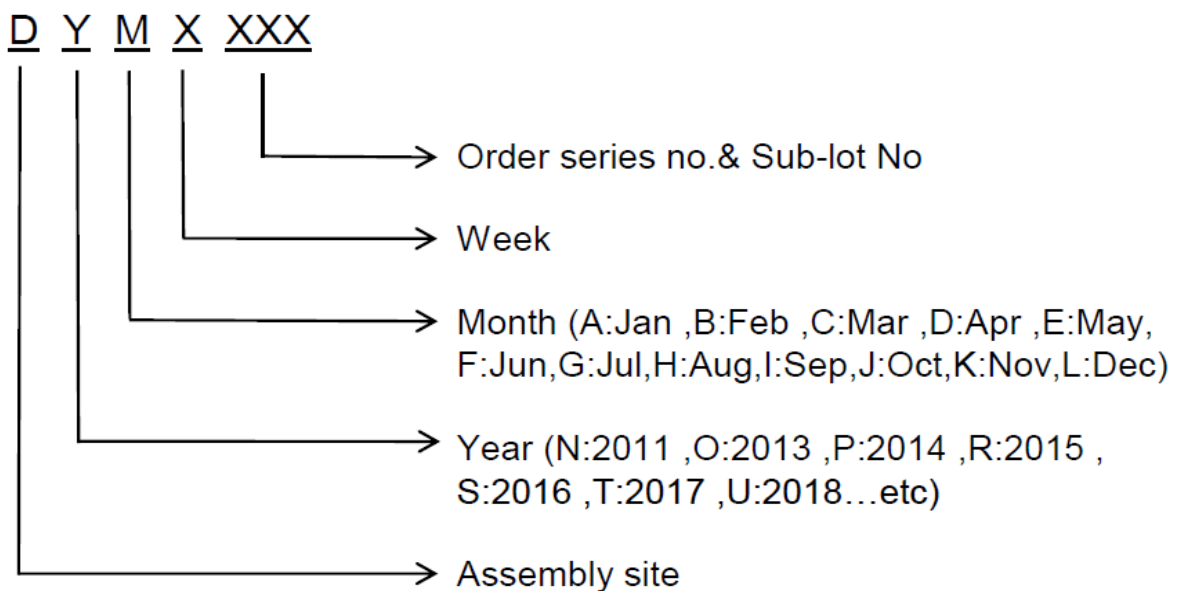
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C. Lot No.&Date Code rule

1. Lot No.



2. Date Code



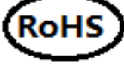

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D.Label rule

标签内容(Label content)



1	Label Size	30 * 90 mm
2	Font style	Times New Roman or Arial (或可区分英文”0”和数字”0”，”G和”Q”的字型即可)
3	U-NIKC	Height: 4 mm
4	Package	Height: 2 mm
5	Date	Height: 2 mm Shipping date: YYYY/MM/DD, ex. 2008/09/12
6	Device	Height: 3 mm (Max: 16 Digit)
7	Lot	Height: 3 mm (Max: 9 Digit) Sub lot
8	D/C	Height: 3 mm (Max: 7 Digit)
9	QTY	Height: 3 mm (Max: 6 Digit) Thousand mark is no needed
10	RoHS label	 long axis: 12 mm minor axis:6 mm bottom color: White Font color: Black Font style: Arial
11	Halogen Free label	 Diameter: 10 mm bottom color: Green Font color: Black Font style: Arial
12	Scan information	Device / Lot / D/C / QTY , Insert “ / “ between every parts. for example: P3055LDG/G12345601/GGG2301/2000 DPI (Dots per inch): Over 300 dpi Code : Code 128 Height: 6 mm at least